## Amendments to the Claims:

The following listing of claims will replace all prior versions, and listings, of claims in the application:

- 1. (Original) A field-effect transistor comprising:
- a gate electrode formed at one side of a base substrate;
- a source electrode formed at the one side of the base substrate:
- a drain electrode formed at the one side of the base substrate;

an insulation layer formed between the gate electrode and the source electrode and between the gate electrode and the drain electrode;

an organic semiconductor layer formed around the source electrode and the drain electrode; and

a reformed layer attached between the insulation layer and the organic semiconductor layer and containing a compound having the CN group in a molecule.

- 2. (Original) A field-effect transistor comprising:
- a gate electrode formed at one side of a base substrate;
- a source electrode formed at the one side of the base substrate;
- a drain electrode formed at the one side of the base substrate;

an insulation layer formed between the gate electrode and the source electrode and between the gate electrode and the drain electrode;

an organic semiconductor layer formed around the source electrode and the drain electrode; and

a reformed layer attached between the insulation layer and the organic semiconductor layer and composed of only a compound having the CN group in a molecule.

3. (Currently Amended) The field-effect transistor according to claim 1-or 2, wherein the compound having the CN group in a molecule contained in or making up the reformed layer is expressed by the following chemical formula:

[Chemical formula 1]

$$(NC)_{n}^{R^{1}} = (R^{4})_{m}^{R^{2}}$$

(in the chemical formula 1, R<sup>1</sup> represents the alkylene group or the polymethylene group whose carbon number k is 1 to 20 and the alkylene group and the polymethylene group may have an ether linkage, n represents an integer of 1 to 2k, R<sup>2</sup>, R<sup>3</sup>, and R<sup>4</sup> each represents an organic group whose carbon number is 1 to 20 independently of each other and at least one of R<sup>2</sup>, R<sup>3</sup>, and R<sup>4</sup> is the alkoxy group whose carbon number is 1 to 5 or the alkylamino group having an alkyl chain whose carbon number is 1 to 20, and M represents at least one kind of atom of Si, Ti, and Al, and when M is Si or T, m=1 and when M is Al, m=0.)

- 4. (Currently Amended) The field-effect transistor according to claim 1-or 2, wherein the compound having the CN group in a molecule contained in or making up the reformed layer is 2-cyanoethyltriethoxy silane.
- 5. (Original) The field-effect transistor according to claim 1, wherein the concentration of the compound having the CN group in a molecule contained in the reformed layer is less than 50 mass%.

- 6. (Original) The field-effect transistor according to claim 1, wherein the thickness of the reformed layer is 0.5 to 500 nm.
- 7. (Currently Amended) The field-effect transistor according to claim 1-or 2, wherein  $C_{min}$  representing the minimum value of the electrostatic capacitance in the electrostatic capacitance-gate voltage characteristic of the field-effect transistor and  $C_{max}$  representing the maximum value of the electrostatic capacitance in the electrostatic capacitance-gate voltage characteristic of the field-effect transistor satisfy the following expression:  $C_{max} \le C_{min} \times 2$ .
- 8. (Currently Amended) The field-effect transistor according to claim 1-or 2, wherein the curve of the rate of change of the drain current obtained from the drain current-time characteristic has a local extreme value, the first derivative is substantially positive, or the rate of change exceeds 1 when 10 seconds elapse after the gate voltage is applied.
- 9. (Original) The field-effect transistor according to claim 2, wherein the hydroxyl group is introduced to the surface or the surface layer of the insulation layer.
- 10. (New) The field-effect transistor according to claim 2, wherein the compound having the CN group in a molecule contained in or making up the reformed layer is expressed by the following chemical formula:

[Chemical formula 1]

$$(NC)_{n}R^{1}-M_{n}R^{3}$$

(in the chemical formula 1, R<sup>1</sup> represents the alkylene group or the polymethylene group whose carbon number k is 1 to 20 and the alkylene group and the polymethylene group may have an ether linkage, n represents an integer of 1 to 2k, R<sup>2</sup>, R<sup>3</sup>, and R<sup>4</sup> each represents an organic group whose carbon number is 1 to 20 independently of each other and at least one of R<sup>2</sup>, R<sup>3</sup>, and R<sup>4</sup> is the alkoxy group whose carbon number is 1 to 5 or the alkylamino group having an alkyl chain whose carbon number is 1 to 20, and M represents at least one kind of atom of Si, Ti, and Al, and when M is Si or T, m=1 and when M is Al, m=0.)

- 11. (New) The field-effect transistor according to claim 2, wherein the compound having the CN group in a molecule contained in or making up the reformed layer is 2-cyanoethyltriethoxy silane.
- 12. (New) The field-effect transistor according to claim 2, wherein  $C_{min}$  representing the minimum value of the electrostatic capacitance in the electrostatic capacitance-gate voltage characteristic of the field-effect transistor and  $C_{max}$  representing the maximum value of the electrostatic capacitance in the electrostatic capacitance-gate voltage characteristic of the field-effect transistor satisfy the following expression:

13. (New) The field-effect transistor according to claim 2, wherein the curve of the rate of change of the drain current obtained from the drain current-time characteristic has a

 $C_{max} \leq C_{min} \times 2$ .

local extreme value, the first derivative is substantially positive, or the rate of change exceeds 1 when 10 seconds elapse after the gate voltage is applied.